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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







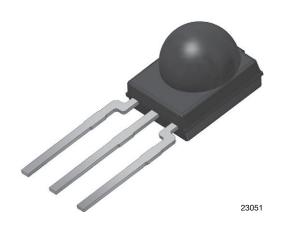


www.vishay.com

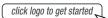
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HALOGEN **FREE**

IR Receiver Modules for Remote Control Systems

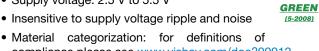


DESIGN SUPPORT TOOLS



FEATURES

- Improved dark sensitivity
- · Improved immunity against optical noise
- · Improved immunity against Wi-Fi noise
- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- compliance please see www.vishay.com/doc?99912



MECHANICAL DATA

Pinning for TSOP13...:

 $1 = OUT, 2 = GND, 3 = V_S$

DESCRIPTION

Models

The TSOP13... series devices are the latest generation miniaturized IR receiver modules for infrared remote control systems. This series provides improvements in sensitivity to remote control signals in dark ambient as well as in sensitivity in the presence of optical disturbances e.g. from CFLs. The robustness against spurious pulses originating from Wi-Fi signals has been enhanced.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP131.., TSOP133.., and TSOP135.. series devices are designed to receive short burst codes (6 or more carrier cycles per burst). The third digit designates the AGC level (AGC1, AGC3, or AGC5) and the last two digits designate the band-pass frequency (see table below). The higher the AGC, the better noise is suppressed, but the lower the code compatibility. AGC1 provides basic noise suppression, AGC3 provides enhanced noise suppression and AGC5 provides maximized noise suppression. Generally, we advise to select the highest AGC that satisfactorily receives the desired remote code.

These components have not been qualified to automotive specifications.

PARTS TABLE					
AGC		BASIC NOISE SUPPRESSION (AGC1)	ENHANCED NOISE SUPPRESSION (AGC3)	MAXIMIZED NOISE SUPPRESSION (AGC5)	
Carrier frequency	30 kHz	TSOP13130	TSOP13330	TSOP13530	
	33 kHz	TSOP13133	TSOP13333	TSOP13533	
	36 kHz	TSOP13136	TSOP13336 (1)	TSOP13536	
	38 kHz	TSOP13138	TSOP13338 (2)(4)	TSOP13538	
	40 kHz	TSOP13140	TSOP13340	TSOP13540	
	56 kHz	TSOP13156	TSOP13356 (3)	TSOP13556	
Package		Minimold			
Pinning		1 = OUT, 2 = GND, 3 = V _S			
Dimensions (mm)		5.4 W x 6.35 H x 4.9 D			
Mounting		Leaded			
Application		Remote control			
Best choice for		(1) RCMM (2) RECS-80 Code (3) r-map (4) XMP-1, XMP-2			

Note

· 30 kHz and 33 kHz only available on written request

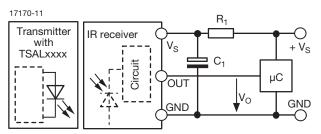
TSOP131.., TSOP133.., TSOP135..

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BLOCK DIAGRAM

16833-13 30 kΩ Input AGC Band pass Demodulator 2

APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.8 \text{ V}$

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Supply voltage		Vs	-0.3 to +6	V	
Supply current		I _S	3	mA	
Output voltage		V _O	-0.3 to (V _S + 0.3)	V	
Output current		Io	5	mA	
Junction temperature		T _j	100	°C	
Storage temperature range		T _{stg}	-25 to +85	°C	
Operating temperature range		T _{amb}	-25 to +85	°C	
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW	
Soldering temperature	t ≤ 10 s, 1 mm from case	T _{sd}	260	°C	

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_{V} = 0, V_{S} = 3.3 V$	I _{SD}	0.55	0.70	0.90	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.80	-	mA
Supply voltage		Vs	2.5	-	5.5	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, $I_F = 50$ mA	d	-	30	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 3.0/f_0 < t_{po} < t_{pi} + 3.5/f_0, \\ test signal see Fig. 1$	E _{e min.}	-	0.08	0.15	mW/m²
Maximum irradiance	$t_{pi} \text{ - } 3.0/f_0 < t_{po} < t_{pi} + 3.5/f_0, \\ \text{test signal see Fig. 1}$	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 45	-	deg

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TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

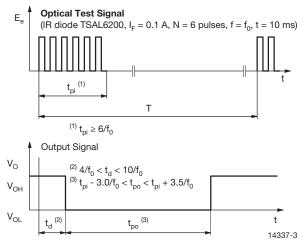


Fig. 1 - Output Delay and Pulse-Width

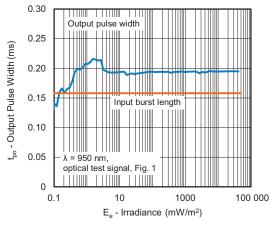
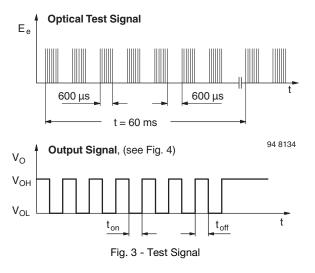


Fig. 2 - Pulse-Width vs. Irradiance in Dark Ambient



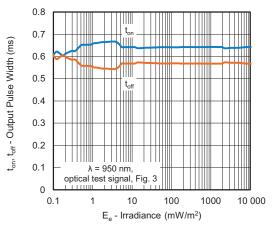


Fig. 4 - Pulse-Width vs. Irradiance in Dark Ambient

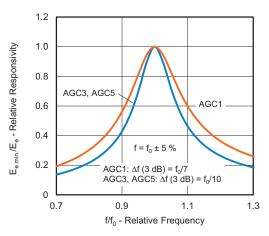


Fig. 5 - Frequency Dependence of Responsivity

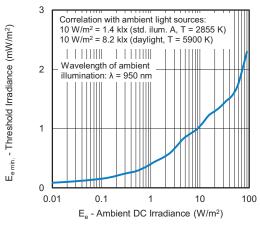


Fig. 6 - Sensitivity in Bright Ambient

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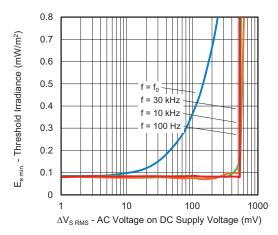


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

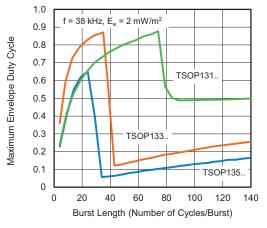


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

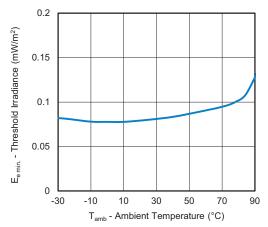


Fig. 9 - Sensitivity vs. Ambient Temperature

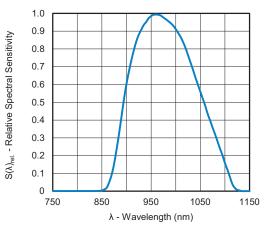


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

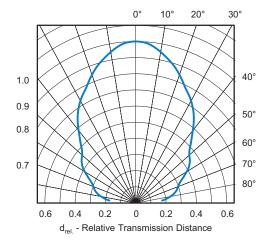


Fig. 11 - Directivity

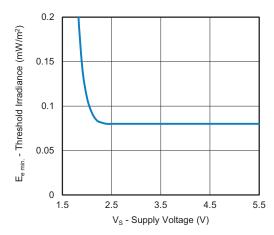


Fig. 12 - Sensitivity vs. Supply Voltage



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SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal presented to the device in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14).
- 2.4 GHz and 5 GHz Wi-Fi

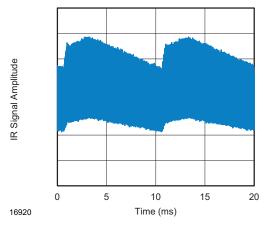


Fig. 13 - IR Disturbance from Fluorescent Lamp With Low Modulation

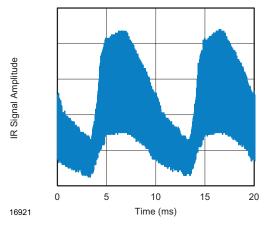


Fig. 14 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP131	TSOP133	TSOP135
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 70 cycles ≥ 10 cycles	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 1 x burst length	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	1800	2800	1800
RCMM code	Yes	Preferred	Yes
XMP-1 code	Yes	Preferred	Yes
r-map code	Yes	Preferred	Yes
Suppression of interference from fluorescent lamps	Fig. 13	Fig. 13 and Fig. 14	Fig. 13 and Fig. 14

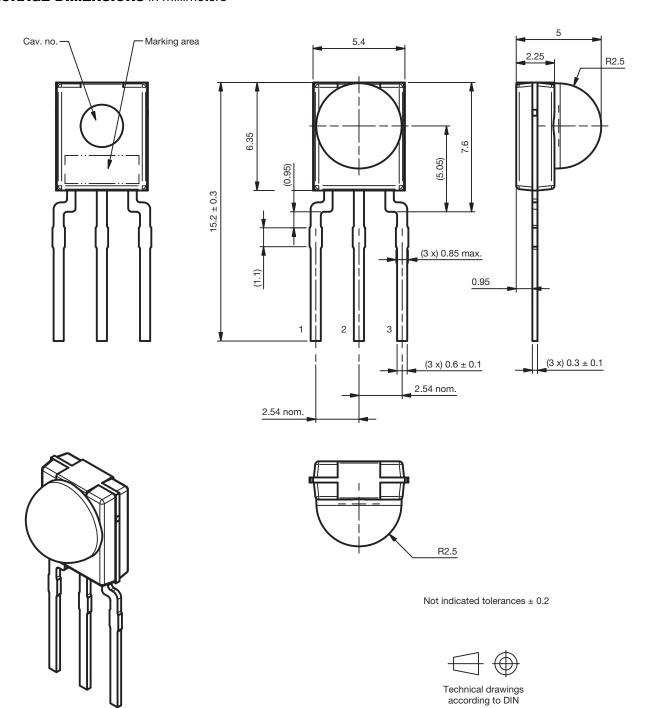
Note

• For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP132.., TSOP134.., TSOP136..

specification.

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PACKAGE DIMENSIONS in millimeters



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TSOP131.., TSOP133.., TSOP135..

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BULK PACKAGING

Standard shipping for minimold is in conductive plastic bags. The packing quantity is determined by weight and the number of components per carton may vary by a maximum of \pm 0.3 %.

ORDERING INFORMATION

Examples: TSOP13338

TSOP13356VI1 TSOP13338SS1F

For more information, see: www.vishay.com/doc?80076

PACKAGING QUANTITY

- 300 pieces per bag (each bag is individually boxed)
- 6 bags per carton



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